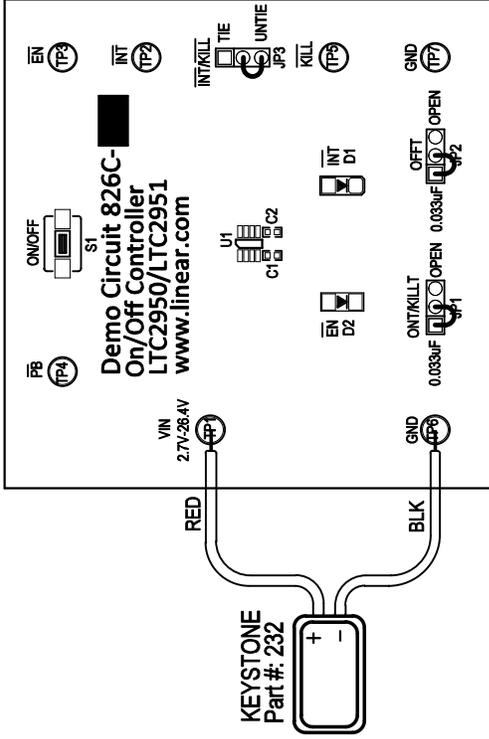


REVISION HISTORY

ECO	REV	DESCRIPTION	APPR	DATE
—	C	PRODUCTION	Dilian Reyes	Nov 19, 2013

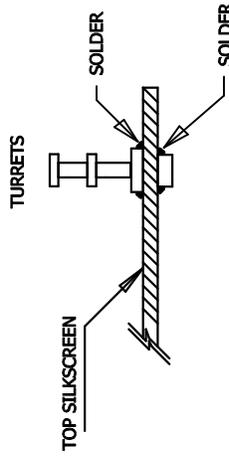


BOARD ASSEMBLY

DC826C-A	U1	LTC2950CTS8-2
DC826C-B		LTC2951CTS8-2

NOTES: UNLESS OTHERWISE SPECIFIED

1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER TOP SIDE SMD. MAXIMUM SOLDER TEMPERATURE IS 240 deg C.
3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
4. INSTALL SHUNT AS SHOWN ON ASSY DRAWING.
5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.



APPROVALS

PCB DES.	RB
APP ENG.	Dilian Reyes
SCALE = NONE	



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TITLE: TOP ASSEMBLY DRAWING
On/Off Controller

SIZE	IC NO. LTC2950/LTC2951	REV.	1
N/A	DEMO CIRCUIT 826C		
FILENAME: 826C-Rev1.PCB		SHT 1 OF 2	